

⊕ -H PARTS HAVE HEX NUT COUPLING WITH LOCK WIRE HOLES.

PANEL THICKNESS: 3.2 MAX

- INSULATOR, PTFE.
 SOLDERSHIELD DEVICE. TIN PLATED COPPER BRAID WITH ACTIVATED ROSIN FLUX.
- 8. SOLDER PREFORM (ON L AND M SIZE ONLY). Sn63 Pb37 SOLDER ALLOY WITH MILDLY ACTIVATED ROSIN FLUX.
- 9. HEAT SHRINKABLE INSULATION SLEEVE, BLACK. RADIATION CROSS-LINKED MODIFIED POLYOLEFIN WITH ADHESIVE.

 10. INSULATOR (EXCEPT FOR ANGLE PLUG), PTFE.

 11. BODY, NICKEL PLATED BRASS.

APPLICATION:

- 1. THESE CONTROLLED SOLDERING DEVICES ARE DESIGNED TO CONNECT, WITH A MIL-PRF-39012 TNC INTERMATABLE PART, A 50Ω SINGLE OR DOUBLE BRAIDED COAXIAL HAVING A:

 -TIN OR SILVER PLATED COPPER OUTER CONDUCTOR.

 -TIN OR SILVER PLATED INNER CONDUCTOR.

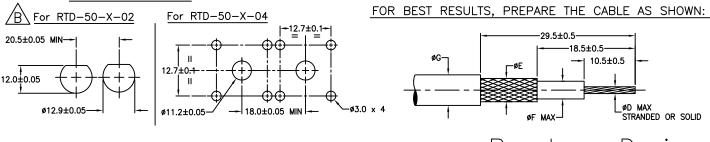
 AND INSULATION RATED FOR AT LEAST +85°C.
- AND INSULATION MATED FOR AT LEAST +00 C.

 2. TEMPERATURE RANGE:

 * WITH BLACK SLEEVE: -55°C TO 100°C.

 * WITHOUT BLACK SLEEVE: -55°C TO 150°C.

 3. FOR INSTALLATION PROCEDURE AND APPLICATION EQUIPMENT, CONSULT RPIP-683-00.



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Raychem Devices

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UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETERS.				1 JO OTTIVI TING			
TOLERANCES: 0.00 ——— ANGLES: — 0.0 ——— ROUGHNESS 0 ——— IN MICRON	ROUGHNESS SHOULD EVALUAT		TIME. USERS LITY OF THE	DOCUMENT NO: RTD-50-Y-XX /-XX-H			
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